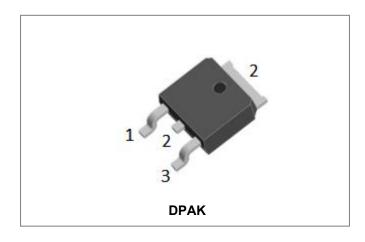






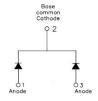
## MBRD650CT/MBRD660CT SCHOTTKY RECTIFIER



### **Features**

- 150℃ T<sub>J</sub> operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- "-A" is an AEC-Q101 qualified device
- Terminals finish: Tin Lead-free plated
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

### **Circuit Diagram**



#### **Applications**

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery charging

### Maximum Ratings@Tc = 25°C unless otherwise specified

Characteristics	Symbol	Condition	Max.		Units
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>		50	MBRD650CT	\/
Working Peak Reverse Voltage DC Blocking Voltage	$V_{RWM}$ $V_{R}$	-	60	MBRD660CT	V
Average Rectified Forward Current	I <sub>F (AV)</sub> T <sub>C</sub> =146°C, In DC	T <sub>0</sub> =146°C In DC	3(peg leg)		Α
Average rectified Forward outrent		6(peg device)			
Peak One Cycle Non-Repetitive Surge Current(peg leg)	I <sub>FSM</sub>	8.3 ms, half Sine pulse	75		Α

#### **Electrical Characteristics:**

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop (per leg) *	V <sub>F1</sub>	@ 3 A, Pulse, T <sub>J</sub> = 25 °C @ 6 A, Pulse, T <sub>J</sub> = 25 °C	0.55 0.71	0.70 0.90	V
	V <sub>F2</sub>	@ 3 A, Pulse, T <sub>J</sub> = 125 °C @ 6 A, Pulse, T <sub>J</sub> = 125 °C	0.49 0.62	0.65 0.85	V
Reverse Current (per leg) *	I <sub>R1</sub>	$@V_R = \text{rated } V_{R,} T_J = 25 ^{\circ}\text{C}$	0.01	0.1	mA
	I <sub>R2</sub>	@V <sub>R</sub> = rated V <sub>R</sub> , T <sub>J</sub> = 125 °C	5	15	mA
Junction Capacitance(per leg)	Ст	$@V_R = 5V, T_C = 25  ^{\circ}C, f_{SIG} = 1MHz$	121	200	pF

<sup>\*</sup> Pulse width < 300 µs, duty cycle < 2%

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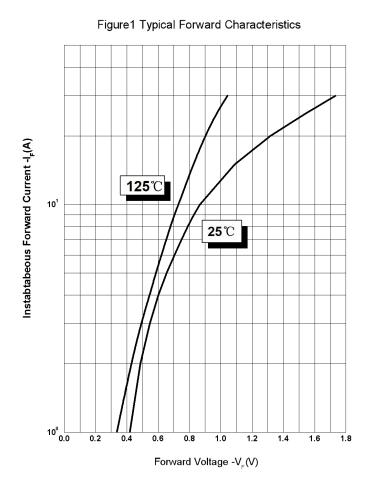


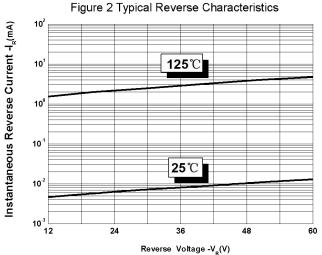


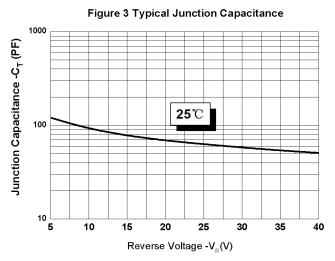
# **Thermal-Mechanical Specifications:**

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T <sub>stg</sub>	-	-55 to + 150	°C
Typical Thermal Resistance Junction to Case	R <sub>0</sub> JC	-	2	°C/W
Approximate Weight	wt	-	0.39	g
Case Style	DPAK			

## **Ratings and Characteristics Curves**







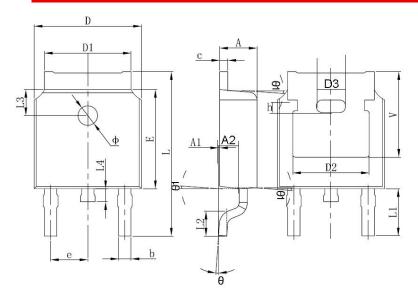
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### **Mechanical Dimensions DPAK**



The outline from different package houses may have slight differences. So the outline above is just schematic. The dimensions are controlled per specifications.

Symbol	Dimensions in millimeters		
,	Min.	Typical	Max.
Α	2.18	-	2.39
A1	-	-	0.13
b	0.64	-	0.89
С	0.46	-	0.89
D	6.35	-	6.73
D1	4.95	-	5.46
D2	4.32	-	-
E	5.97	6.1	6.22
е	2.29BSC		
L	9.4	-	10.41
L1	2.90 REF.		
L2	1.4	1.52	1.78
L3	1.60 REF.		
L4	-		1.02
Ф	1.1	-	1.3
Θ	0°	-	10°
V	5.21	-	-

## **Ordering Information**

Device	Package	Shipping
MBRD650CT MBRD660CT	DPAK (Pb-Free)	2500pcs / reel
MBRD650CTTR MBRD660CTTR	DPAK (Pb-Free)	2500pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel Packaging specification.

## **Marking Diagram**



Where XXXXX is YYWWL

 MBR
 = Device Type

 D
 = Package type

 6
 = Forward Current (6A)

 50
 = Reverse Voltage (50V)

 CT
 = Configuration

 SSG
 = SSG

 YY
 = Year

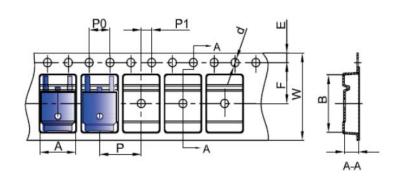
 WW
 = Week

= Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

# **Carrier Tape Specification DPAK**



SYMBOL	Millimeters		
STWIDOL	Min.	Max.	
Α	6.80	7.00	
В	10.40	10.60	
С	2.60	2.80	
d	Ф1.45	Ф1.65	
E	1.65	1.85	
F	7.40	7.60	
P0	3.90	4.10	
Р	7.90	8.10	
P1	1.90	2.10	
W	15.90	16.30	

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